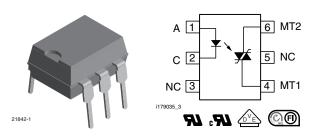


Optocoupler, Phototriac Output, High dV/dt, Low Input Current



DESCRIPTION

The VO4254 and VO4256 phototriac consists of a GaAs IRLED optically coupled to a photosensitive non-zero crossing TRIAC packaged in a DIP-6 package.

High input sensitivity is achieved by using an emitter follower phototransistor and a cascaded SCR predriver resulting in an LED trigger current of 1.6 mA for bin D, 2 mA for bin H, and 3 mA for bin M.

The new non zero phototriac family use a proprietary dV/dt clamp resulting in a static dV/dt of greater than 5 kV/µs.

The VO4254 and VO4256 phototriac isolates low-voltage logic from 120 V_{AC} , 240 V_{AC} , and 380 V_{AC} lines to control resistive, inductive, or capacitive loads including motors, solenoids, high current thyristors or TRIAC and relays.

FEATURES

- High static dV/dt 5 kV/µs
- High input sensitivity 1.6 mA, 2 mA, and 3 mA
- 400 V and 600 V blocking voltage
- 300 mA on-state current
- Isolation test voltage 5300 V_{RMS}
- Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912







APPLICATIONS

- · Solid-state relays
- Industrial controls
- Office equipment
- Consumer appliances

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- cUL file no. E52744, equivalent to CSA bulletin 5A
- DIN EN 60747-5-5 (VDE 0884) available with option 1
- FIMKO: FI25250

ORDERING INFORMATION						
V O 4 2 5 # X - X O O # T PART NUMBER PACKAGE OPTION TAPE AND REEL OPTION Option 7 10.16 mm 1						
AGENCY		V _{DRM} 400			V _{DRM} 600	
CERTIFIED/PACKAGE	TRIGGER CURRENT, I _{FT} (mA)					
UL, cUL, FIMKO	1.6	2	3	1.6	2	3
DIP-6	VO4254D	VO4254H	VO4254M	VO4256D	VO4256H	VO4256M
DIP-6, 400 mil, option 6	VO4254D-X006	VO4254H-X006	VO4254M-X006	VO4256D-X006	VO4256H-X006	VO4256M-X006
SMD-6, option 7	VO4254D-X007T	VO4254H-X007T	VO4254M-X007T	VO4256D-X007T	VO4256H-X007T	VO4256M-X007T
UL, cUL, FIMKO, VDE	1.6	2	3	1.6	2	3
DIP-6	-	-	-	VO4256D-X001	-	-



PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V_{R}	6	V
Forward current			I _F	60	mA
Power dissipation			P _{diss}	100	mW
Derate from 25 °C				1.33	mW/°C
OUTPUT					
Dook off state voltage		VO4254D/H/M	V_{DRM}	400	V
Peak off-state voltage		VO4256D/H/M	V_{DRM}	600	V
RMS on-state current			I _{TM}	300	mA
Power dissipation			P _{diss}	500	mW
Derate from 25 °C				6.6	mW/°C
COUPLER					
Isolation test voltage (between emitter and detector, climate per DIN 500414, part 2, Nov. 74)	t = 1 s		V _{ISO}	5300	V _{RMS}
Storage temperature range			T _{stg}	- 55 to + 150	°C
Ambient temperature range			T _{amb}	- 55 to + 100	°C
Soldering temperature (2)	max. ≤ 10 s dip soldering ≥ 0.5 mm from case bottom		T _{sld}	260	°C

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

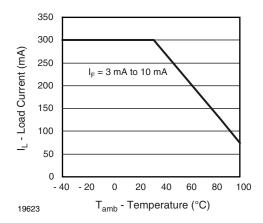


Fig. 1 - Recommended Operating Condition



THERMAL CHARACTERISTICS			
PARAMETER	SYMBOL	VALUE	UNIT
LED power dissipation	P _{diss}	100	mW
Output power dissipation	P _{diss}	500	mW
Maximum LED junction temperature	T _{jmax.}	125	°C
Maximum output die junction temperature	T _{jmax.}	125	°C
Thermal resistance, junction emitter to board	θ_{JEB}	150	°C/W
Thermal resistance, junction emitter to case	θ_{JEC}	139	°C/W
Thermal resistance, junction detector to board	θ_{JDB}	78	°C/W
Thermal resistance, junction detector to case	θ_{JDC}	103	°C/W
Thermal resistance, junction emitter to junction detector	θ_{JED}	496	°C/W
Thermal resistance, case to ambient	$\theta_{\sf CA}$	3563	°C/W

Note

• The thermal characteristics table above were measured at 25 °C and the thermal model is represented in the thermal network below. Each resistance value given in this model can be used to calculate the temperatures at each node for a given operating condition. The thermal resistance from board to ambient will be dependent on the type of PCB, layout and thickness of copper traces. For a detailed explanation of the thermal model, please reference Vishay's Thermal Characteristics of Optocouplers application note.

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	I _F = 10 mA		V_{F}		1.2	1.4	V
Reverse current	V _R = 6 V		I _R		0.1	10	μΑ
Input capacitance	V _F = 0 V, f = 1 MHz		C _I		40		pF
OUTPUT							
Popotitivo pook off state voltage	I 100 uA	VO4254D/H/M	V_{DRM}	400			V
Repetitive peak off-state voltage	$I_{DRM} = 100 \mu A$	VO4256D/H/M	V_{DRM}	600			V
Off-state current	$V_D = V_{DRM}$		I _{DRM}			100	μΑ
On-state voltage	I _T = 300 mA		V_{TM}			3	V
On-current	PF = 1, V _{T(RMS)} = 1.7 V		I _{TM}			300	mA
Critical rate of rise of off-state voltage	$V_D = 0.67 \ V_{DRM}, \ T_J = 25 \ ^{\circ}C$		dV/dt _{cr}	5000			V/µs
COUPLER							
		VO4254D	I _{FT}			1.6	mA
LED trigger current, current required to latch output	V _D = 3 V	VO4254H	I _{FT}			2	mA
		VO4254M	I _{FT}			3	mA
		VO4256D	I _{FT}			1.6	mA
		VO4256H	I _{FT}			2	mA
		VO4256M	I _{FT}			3	mA
Capacitance (input to output)	f = 1 MHz, V _{IO} = 0 V		C _{IO}		0.8		рF

Note

Minimum and maximum values were tested requierements. Typical values are characteristics of the device and are the result of engineering
evaluation. Typical values are for information only and are not part of the testing requirements.



SAFETY AND INSULATION RATINGS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Climatic classification (according to IEC68 part 1)				55/100/21		
Pollution degree (DIN VDE 0109)				2		
Comparative tracking index per DIN IEC112/VDE 0303 part 1, group IIIa per DIN VDE 6110 175 399			175		399	
V _{IOTM}		V_{IOTM}	8000			V
V _{IORM}		V_{IORM}	890			V
P _{SO}		P _{SO}			500	mW
I _{SI}		I _{SI}			250	mA
T _{SI}		T _{SI}			175	°C
Creepage distance			7			mm
Clearance distance			7			mm

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

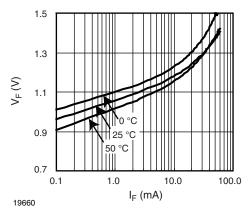


Fig. 2 - Diode Forward Voltage vs. Forward Current

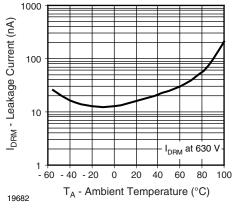


Fig. 4 - Leakage Current vs. Ambient Temperature

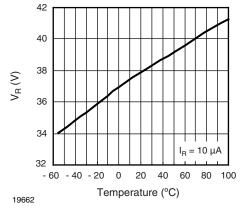


Fig. 3 - Diode Reverse Voltage vs. Temperature

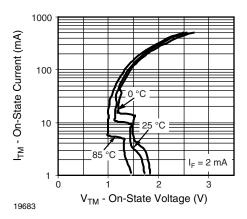


Fig. 5 - On-State Current vs. On-State Voltage



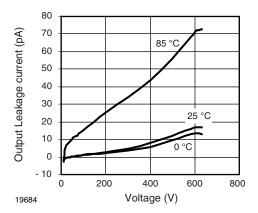


Fig. 6 - Output Off Current (Leakage) vs. Voltage

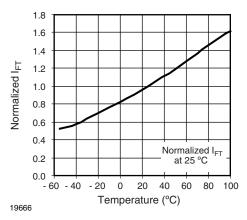


Fig. 7 - Normalized Trigger Input Current vs. Temperature

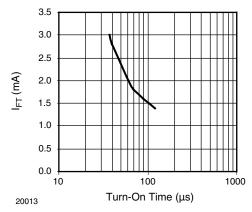


Fig. 8 - I_{FT} vs. Turn-On Time (μ s)

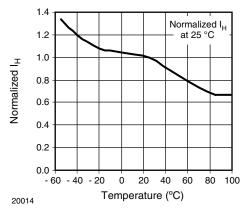


Fig. 9 - Normalized I_H vs. Temperature

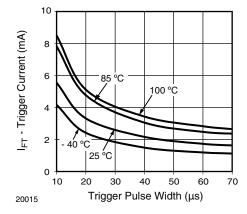
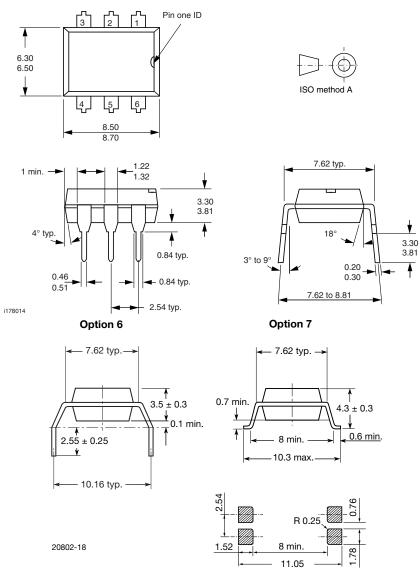


Fig. 10 - I_{FT} vs. LED Pulse Width



PACKAGE DIMENSIONS in millimeters



PACKAGE MARKING (example)



Note

• VDE logo is only marked on option 1 parts. Tape and reel suffix (T) is not part of the package marking.



Footprint and Schematic Information

Vishay Semiconductors

Footprint and Schematic Information for VO4254, VO4256

The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

PART NUMBER	FOOTPRINT / SCHEMATIC
VO4254D	www.snapeda.com/parts/VO4254D/Vishay/view-part
VO4254H	www.snapeda.com/parts/VO4254H/Vishay/view-part
VO4254M	www.snapeda.com/parts/VO4254M/Vishay/view-part
VO4256D	www.snapeda.com/parts/VO4256D/Vishay/view-part
VO4256D-X001	www.snapeda.com/parts/VO4256D-X001/Vishay/view-part
VO4256H	www.snapeda.com/parts/VO4256H/Vishay/view-part
VO4256M	www.snapeda.com/parts/VO4256M/Vishay/view-part

For technical issues and product support, please contact optocoupleranswers@vishay.com.





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